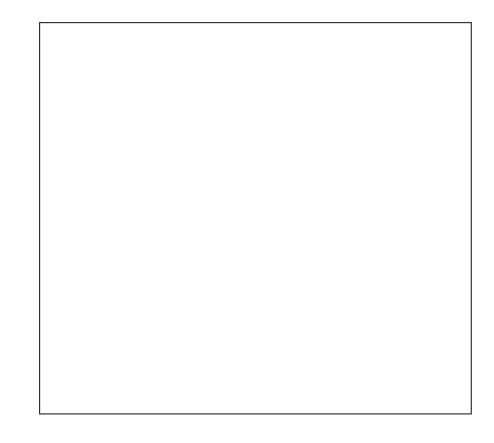


TABLE 1

Variant	Label text	
001	ChangeMe!	
002	ChangeMe!	

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9184	REV: A	SUN REV	: Not In VersionControl	
IGNORE -> Top Overlay					
PLOT NAME = Top Assembly Drawing	GENERATED : 10/23/	/2013 12:35:48	PM	TEXAS INSTRUMENTS	



PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9184	REV: A	SUN REV:	Not In VersionControl	
IGNORE ->			er l ay	Bottom Overlay	
PLOT NAME = Bottom Assembly Drawing	GENERATED : 10/23/	<sup>2</sup> 2013 12: 35: 49	PM	TEXAS INSTRUMENTS	

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